

SMD Molding Power Inductor

Features

- 1. Magnetically shielded construction, low DC resistance;
- The use of magnetic iron powder ensure capability for large current;
- 3. Low audible core noise:
- 4. Ideal for DC-DC converter applications in hand held personal computer and etc;
- 5、Frequency Range: up to 30MHz;
- 6、RoHS compliant。

Applications

- 1、Smart phone、MID;
- 2. Next-generation mobile devices with multifunction such as adding color TV and digital movie cameras;
- 3、Flat-screen TVs, blue-ray disc recorders, set top box;
- 4. Notebooks, desktop computers, servers, graphic cards;
- 5. Portable gaming devices, personal navigation systems, personal multimedia devices;
- 6. Automotive systems;
- 7. Telecomm base stations.

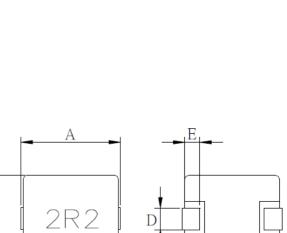
Lead Free Part Numbering

CMLO 0420 H 2R2 M T T (1) (2) (3) (4) (5) (6) (7)

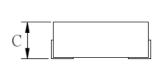
- (1) Series Type
- (2) Dimension: AXC
- (3) Material Code
- (4) Inductance: $2R2=2.2\mu H$;

 $100=10\mu H$; $101=100\mu H$

- (5) Inductance Tolerance: M=±20%, N=±30%
- (6) Company Code
- (7) Packaging: packed in embossed carrier tape







Dimensions

Series	A±0.2(mm)	B±0.2 (mm)	C (mm)	D±0.1 (mm)	E±0.1 (mm)
CMLO0420H	4.4	4.2	2.0 Max	1.5	0.8

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◆ Specification

Part Number	Rdc Lo(μ H) (m Ω)		Test a	HEAT RATING CURRENT(Idc)	SATURATION CURRENT(Isat)				
rait Nullibel	±20 %	% Typ. Max cond		condition	DC AMPS1 (Typ.)	DC AMPS2 (Typ.)			
CMLO0420H Series									
CMLO0420HR10MTT	0.10	3.0	4.0	100KHz/1V	13	22			
CMLO0420HR22MTT	0.22	5.0	6.6	100KHz/1V	9.5	12.5			
CMLO0420HR33MTT	0.33	8.3	11	100KHz/1V	10	12			
CMLO0420HR47MTT	0.47	10.5	14	100KHz/1V	7.5	9.5			
CMLO0420HR56MTT	0.56	12.0	16	100KHz/1V	7.0	9.0			
CMLO0420HR68MTT	0.68	13.5	18	100KHz/1V	7.0	8.0			
CMLO0420H1R0MTT	1.0	20.3	27	100KHz/1V	6.0	7.0			
CMLO0420H1R2MTT	1.2	20.3	27	100KHz/1V	6.0	6.5			
CMLO0420H1R5MTT	1.5	34.5	46	100KHz/1V	5.0	5.5			
CMLO0420H2R2MTT	2.2	43.5	58	100KHz/1V	4.5	5.0			
CMLO0420H3R3MTT	3.3	65.3	87	100KHz/1V	3.3	3.5			
CMLO0420H4R7MTT	4.7	78.8	105	100KHz/1V	2.8	3.0			
CMLO0420H6R8MTT	6.8	131.3	175	100KHz/1V	2.4	2.5			
CMLO0420H100MTT	10	211.5	282	100KHz/1V	1.6	2.0			

NOTES:

- 1. DC current (ldc) that will cause an approximate $\triangle T$ of 40°C
- 2. DC current (Isat) that will cause Lo to drop approximately 20%
- 3. All test data is referenced to 25°C ambient
- 4. Operating Temperature Range -55°C to +150°C
- 5. The part temperature (ambient + temp rise) should not exceed 150° C under the worst operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect

the part temperature. Part temperature should be verified in the end application.

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♦ Reliability Test

Item	Specification and Requirement	Test Method	
Solderability	No case deformation or change in apperarance New solder coverage More than 90%	1.Preheat: 155℃±5℃ , 60S±2S 2.Tin: lead-free. 3.Temperature:245℃±5℃ , flux 3.0S±0.5S.	
Mechanical shock	1. No case deformation or change in apperarance2. △L/Lo≤±10%	 Acceleration: 100G Pulse time:: 6ms 3 times in each positive and negative direction of 3 mutual perpendicular directions 	
Mechanical vibration	1. No case deformation or change in apperarance2. △L/Lo≤±10%	1. The test samples shall be soldered to the board. Then it shall be submitted to below test conditions. Fre. Range 10~55Hz Total Amplitude 1.5mm Sweeping Method 10Hz to 55Hz to 10Hz Time For 2 hours on each X,Y,Z axis. 2. Recovery: At least 2 hours of recovery under the standard condition after the test, followed by the measurement within 24 ±2 hours.	
Thermal Shock	Inductance change: Within ± 10% Without distinct damage in appearance	 First -55℃ for 30 minutes, last 125℃ for 30 minutes as 1 cycle. Go through 1000 cycles. Max transfer time is 2 minutes. Measured at room temperature after placing for 24±2 hours 	
Humidity Resistance	Inductance change: Within ± 10% Without distinct damage in appearance	1.Reflow 2 times, 2.85℃,85%RH,1000 hours 3.Measured at room temperature after placing for 24±2 hours	
Low temperature storage	Inductance change: Within ± 10% Without distinct damage in appearance	 Temperature: -55 ± 2°C Time: 1000 hours Measured at room temperature after placing for 24±2 hours 	
High temperature storage	Inductance change: Within ± 10% Without distinct damage in appearance	 Temperature: +125 ± 2°C Time: 1000 hours Measured at room temperature after placing for 24±2 hours 	

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	Inductance change:	1、Run through IR reflow for 2 times;
	Within ± 10% Without distinct damage	2. Place the 100mm X 40mm board into a fixture
	in appearance	similar to the one shown in below Figure with the
		component facing down
		3. The apparatus shall consist of mechanical means
		to apply a force which will bend the board (D) x = 2
		mm minimum.
		4. The duration of the applied forces shall be 60±5
Board Flex		sec. The force is to be applied only once to the oard.
		Support Solder Chip Printed circuit board before to
		Printed circuit board under test Printed circuit board under test Displacement
	No removal or split of the termination or	1. The test samples shall be soldered to the board
	other defects shall occur.	2. Push the product vertically from the side of the
		sample using the thrust tester.
		3、Automotive electronics: 17.7N,60S±1s,X,
Terminal		Ydirect.
Strength		X direct
		Y direct

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♦ Recommended Soldering Technologies

(1) Re-flowing Profile

Preheat condition: 150 ~200 °C/60~180sec.

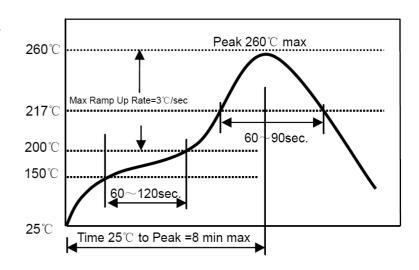
Allowed time above 217°C: 80~120sec.

Max temp: 260°C

Max time at max temp: 10 sec.

Solder paste: Sn/3.0Ag/0.5Cu

Allowed Reflow time: 2x max



(2) Iron Soldering Profile

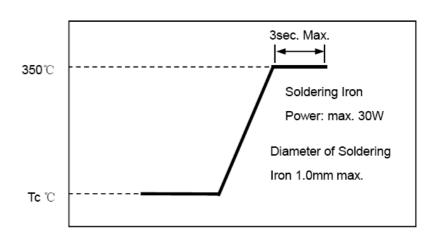
Iron soldering power: Max. 30W

Pre-heating: 150 °C/60sec.

Soldering time: 3sec. Max.

Solder paste: Sn/3.0Ag/0.5Cu

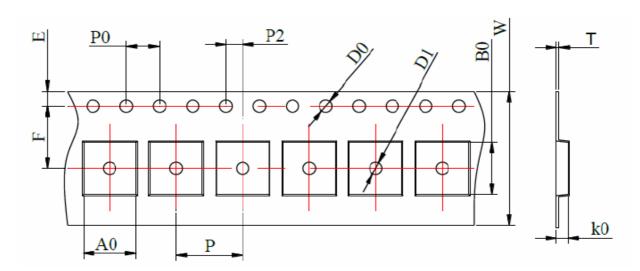
Max.1 times for iron soldering





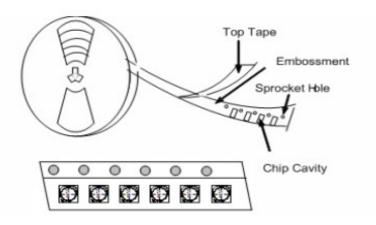
◆ Packaging Information

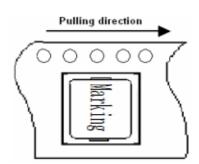
(1) Tape Packaging Dimensions (Unit: mm)



Typo					Тар	e dimer	nsions (n	nm)				
Туре	W	Р	P0	P2	D0	D1	Т	A0	В0	K0	Е	F
CMLO0420	12 ±0.3	8 ±0.1	4 ±0.1	2 ±0.1	1.5 ±0.1	1.5 ±0.1	0.35 ±0.05	4.5 ±0.1	4.85 ±0.1	2.3 ±0.1	1.75 ±0.1	5.5 ±0.1

Taping Drawings (UNIT:mm)

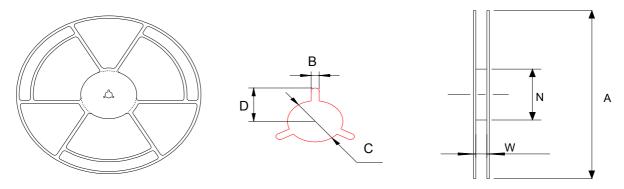




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(2) Reel Dimensions (Unit: mm)



А	W	N	В	С	D
330+2.0	12.8±0.2	97±0.5	2.2+0.5	13.0±0.2	10.75±0.25

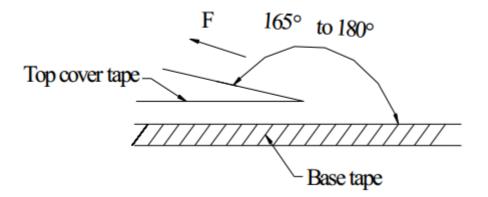
(3) Packaging Quantity(PCS)

Typo	Standard Quantity				
Туре	Reel	Inner box	Carton box		
CMLO0420	3000 pcs / reel	4Reel / box (12000 pcs)	4 Middle boxes, (48,000 pcs)		

(4) Peel force of top cover tape

The peel speed shall be about 300mm/minute

The peel force of top cover tape shall be between 0.1 to 1.3 N



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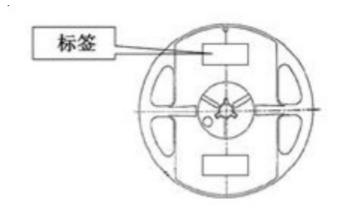
(5) Reel Label

Label on the reel

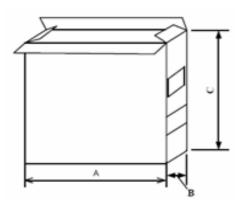
- · Customer's part Number
- Lot Number
- Quantity
- date code

Shipping Label

- Customer's part Number
- · Manufacturer's part Number
- Quantity
- · date code

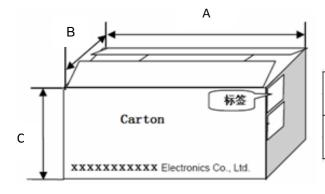


(6) Inner Box



Packaging type	A (mm)	B (mm)	C (mm)	
lnner box	335	70	340	

(7) Carton



Packaging type	A (mm)	B (mm)	C (mm)
type	360	360	360